CGS74CT2524

CGS74CT2524 1 to 4 Minimum Skew (300 ps) Clock Driver

Literature Number: SNOS683A

National Semiconductor

September 1995

CGS74CT2524
1 to 4 Minimum Skew (300 ps) Clock Driver

General Description

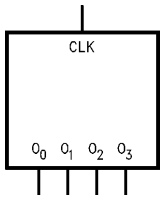
These minimum skew clock drivers are designed for Clock Generation and Support (CGS) applications operating at high frequencies. This device guarantees minimum output skew across the outputs of a given device.

Skew parameters are also provided as a means to measure duty cycle requirements as those found in high speed clocking systems. The CGS74CT2524 is a minimum skew clock driver with one input driving four outputs, specifically designed for signal generation and clock distribution applications.

Features

- Guaranteed 300 ps pin-to-pin skew (t_{OSHL} and t_{OSLH})
- Implemented on National's FACT™ family process
- 1 input to 4 outputs low skew clock distribution
- Symmetric output current drive: 24 mA I_{OH}/I_{OL}
- Industrial temperature of −40°C to +85°C
- 8-pin SOIC package
- Low dynamic power consumption above 20 MHz
- Guaranteed 2 kV ESD protection

Logic Symbol

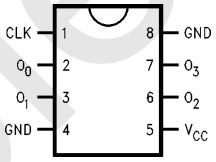


TL/F/11752–1

The output pins act as a single entity and will follow the state of the CLK when the clock distribution chip is selected.

Connection Diagrams

Pin Assignment
SOIC (M)



TL/F/11752–2

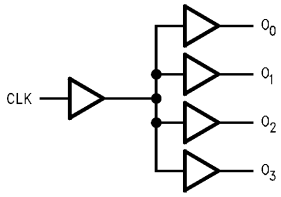
Pin Description

Pin Names	Descripton
CLK	Clock Input
O_0–O_3	Outputs

Truth Table

Inputs	Outputs
CLK	O_0–O_3
L	L
H	H

L = Low Logic Level
H = High Logic Level



TL/F/11752–3

FACT™ is a trademark of National Semiconductor Corporation.

RRD-B30M115/Printed in U. S. A.

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})			−0.5 to 7.0V
DC Input Voltage Diode Current (I_{IK})			
$V = -0.5V$			−20 mA
$V = V_{CC} + 0.5V$			+20 mA
DC Input Voltage (V_I)			−0.5V to (V_{CC} +0.5V)
DC Output Diode (Current) (I_O)			
$V = -0.5V$			−20 mA
$V = V_{CC} + 0.5V$			+20 mA
DC Output Voltage (V_O)			−0.5V to (V_{CC} +0.5V)
DC Output Source or Sink Current (I_O)			±50 mA
DC V_{CC} or Ground Current per Output Pin (I_{CC} or I_{GND})			±50 mA
Storage Temperature (T_{STG})			−65°C to +150°C
Junction Temperature (θ_{JA})	0	225	500 LFM
	M 167	132	117°C/W
	N 115	79	62 °C/W

Recommended Operating Conditions

Supply Voltage (V_{CC})	4.5V to 5.5V
Input Voltage (V_I)	0V to V_{CC}
Output Voltage (V_O)	0 to V_{CC}
Operating Temperature (T_A)	−40°C to +85°C
Input Rise and Fall Times (0.8V to 2.0V)	9.6 ns max

NOTE: *The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the DC and AC Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The Recommended Operating Conditions will define the conditions for actual device operation.*

DC Electrical Characteristics

Over recommended operating conditions unless specified otherwise.

Symbol	Parameter	V_{CC} (V)	CGS74CT2524			Units	Conditions
			$T_A = +25°C$	$T_A = -40°C$ to $+85°C$			
			Typ	Guaranteed Limits			
V_{IH}	Minimum High Level Input Voltage	4.5	1.5	2.0	2.0	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
		5.5	1.5	2.0	2.0		
V_{IL}	Maximum Low Level Input Voltage	4.5	1.5	0.8	0.8	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
		5.5	1.5	0.8	0.8		
V_{OH}	Minimum High Level Output Voltage	4.5	4.49	4.4	4.4	V	$V_{IN} = V_{IH}$ $I_{OUT} = -50\ \mu A$
		5.5	5.49	5.4	5.4		
		4.5		3.86	3.76	V	$V_{IN} = V_{IH}$ $I_{OH} = -24$ mA
		5.5		4.86	4.76		
V_{OL}	Minimum Low Level Output Voltage	4.5	0.001	0.1	0.1	V	$V_{IN} = V_{IL}$ $I_{OUT} = 50\ \mu A$
		5.5	0.001	0.1	0.1		
		4.5		0.36	0.44	V	$V_{IN} = V_{IL}$ $I_{OL} = 24$ mA
		5.5		0.36	0.44		
I_{IN}	Maximum Input Leakage Current	5.5		±0.1	±1.0	mA	$V_I = V_{CC}$, GND
I_{CC_T}	Maximum I_{CC}/Input	5.5	0.6		1.5	mA	$V_I = V_{CC} - 2.1V$
I_{OLD}	Minimum Dynamic Output Current	5.5			75	mA	$V_{OLD} = 1.65V$ Max
I_{OHD}		5.5			−75	mA	$V_{OHD} = 3.85V$ Min
I_{CC}	Maximum Quiescent Supply Current	5.5		8.0	80	μA	$V_{IN} = V_{CC}$ or GND

AC Electrical Characteristics

Over recommended operating conditions unless specified otherwise. All typical values are measured at $V_{CC} = 5V$, $T_A = 25°C$.

Symbol	Parameter	CGS74CT2524 $V_{CC} = 4.5V$ to $5.5V$, $T_A = -40°C$ to $+85°C$, $C_L = 50$ pF, $R_L = 500\Omega$			Units
		Min	Typ	Max	
t_{PLH}	Low-to-High Propagation Delay CLK to O_n	3.5		9.0	ns
t_{PHL}	High-to-Low Propagation Delay CLK to O_n	3.5		9.0	ns

Extended AC Electrical Characteristics

Over recommended operating conditions unless specified otherwise. All typical values are measured at $V_{CC} = 5V$, $T_A = 25°C$.

Symbol	Parameter	CGS74CT2524 $V_{CC} = 4.5V$ to $5.5V$, $T_A = -40°C$ to $+85°C$, $C_L = 50$ pF, $R_L = 500\Omega$				Units
		Package	Min	Typ	Max	
F_{max}	Maximum Operating Frequency			100		MHz
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation (Note 1)	M M (Note 2) N			300 450 500	ps
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation (Note 1)	M M (Note 2) N			300 450 500	ps
t_{PS}	Maximum Skew Pin (Signal) Transition Variation (Note 3)				1.0	ns
t_{rise} t_{fall}	Rise Time/Fall Time (from 0.8V to 2.0V/2.0V to 0.8V)				1.5	ns
T_{High}	Time High	4				ns
T_{Low}	Time Low	4				ns

Note 1: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay from any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH to LOW (t_{OSHL}) or LOW to HIGH (t_{OSLH}) or in opposite directions both HL and LH (t_{OST}). t_{OSHL} and t_{OSLH} are characterized and guaranteed by design @1 MHz.

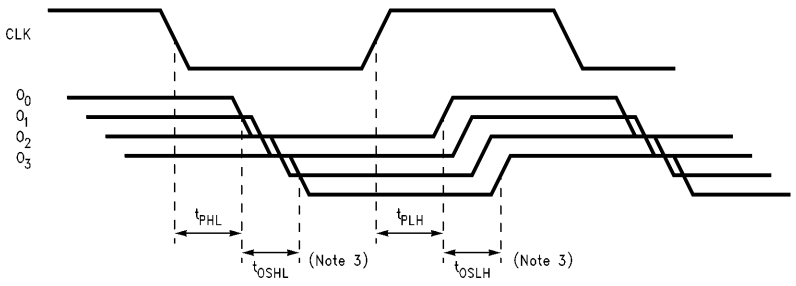
Note 2: Characterized at 66 MHz. Parameter guaranteed by design.

Note 3: Pin transition skew is the absolute difference between High-to-Low and Low-to-High propagation delay measure at a given output pin.

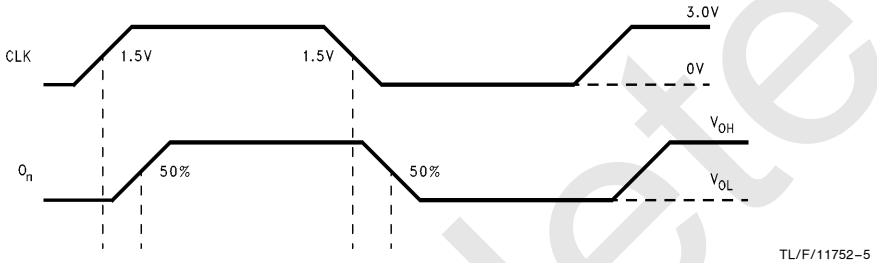
Note 4: Load capacitance includes the test jig.

Timing Diagrams

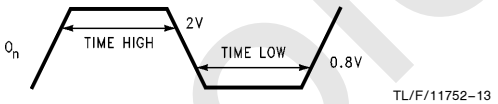
1 to 4 Min-Skew Clock Driver



TL/F/11752–4



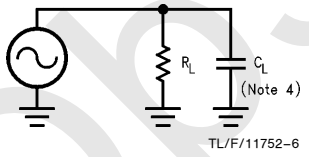
TL/F/11752–5



TL/F/11752–13

Time high is measured with outputs above 2V.
Time low is measured with outputs below 0.8V.

Test Circuit

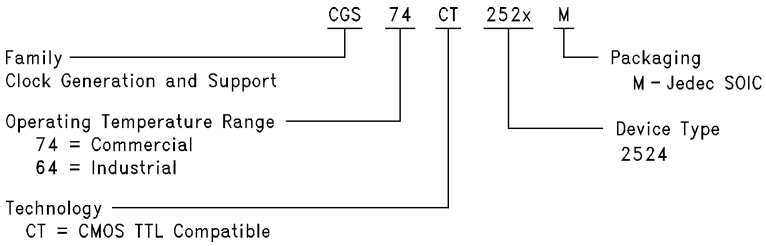


TL/F/11752–6

R_L is 500Ω
C_L is 50 pF for all prop delays and skew measurements.

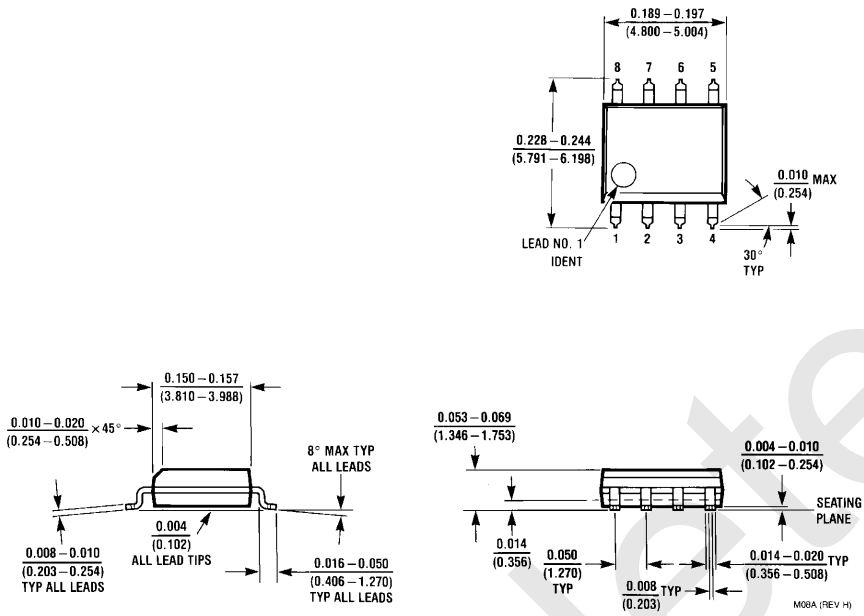
Ordering Information

Contact NSC Marketing for specific data of availability



TL/F/11752–14

Physical Dimensions inches (millimeters)



8 Lead (0.150″ Wide) Molded Small Outline Package (M)
NS Package Number M08A

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@tevm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
	TI E2E Community Home Page		e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265